

834FX



Black Flexible Epoxy, Encapsulating & Potting Compound

834FX is a 2-part, flame-retardant, thermally conductive, flexible epoxy resin that provides extreme environmental, mechanical and physical protection for printed circuit boards and electronic assemblies.

This product is designed for applications where minimizing the physical stress on components is critical. It is good in low temperature and arctic environments, and in applications that involve temperature cycling or rapid temperature changes. It provides the functionality of silicone, but with the durability and cost-effectiveness of epoxy.

Features & Benefits

Flexible and low modulus

Flame-retardant—meets UL 94V-0

Convenient 1A:1B volume mix ratio

Low exotherm

Good adhesion to a wide variety of substrates including metals, composites, glass, ceramics, and many plastics

Excellent electrical insulating characteristics

Non-halogenated flame-retardant fillers

Solvent-free

Cure Instructions

Allow to cure at room temperature for 48 hours, or cure in an oven at one of these time/temperature options:

Temperature	65 °C	80 °C	100 °C
Time	2 h	1 h	30 min



Available Packaging

Part #	Packaging	Net Vol.	Net Wt.
834FX-450ML	2 Bottle kit	450 mL	728 kg
834FX-1.7L	2 Can kit	1.7 L	2.75 kg
834FX-7.4L	2 Can kit	7.2 L	11.6 kg
834FX-40L	2 Pail kit	40 L	64.7 kg

Storage and Handling

Store between 16 and 27 °C in a dry area, away from sunlight (see SDS). Storage below 16 °C can result in crystallization.

Liquid Properties

Chemistry	Epoxy	—
Density	1.6 g/mL (Mixed) 1.6 g/mL (A) 1.6 g/mL (B)	ASTM D1475
Viscosity @ 25 °C	15 000 cP (Mixed) 8 000 cP (A) 16 000 cP (B)	Brookfield Engineering labs Inc. IPCTM-65- Method 2.4.24.4
Mix Ratio	1:1 (Volume) 1:1 (Weight)	—
Working Time ^a	2.5 h	—
Shrinkage	1.6%	Calculated
Shelf Life	5 y	—

^aBased on 100 g sample. Varies by volume and geometry.

Cured Properties

Flame Retardancy	Meets UL 94V-0	—
Color	Black	—
Density	1.6 g/mL	Hydrostatic Weighing
Service Temperature Range	-50–125 °C	—
Intermittent Temperature	-55–165 °C	—
Thermal Conductivity @ 25 °C	0.6 W/(m·K)	ASTM E1461
Specific Heat Capacity @ 25 °C	1.4 J/(g·K)	
Thermal Diffusivity @ 25 °C	0.3 mm ² /s	
Glass Transition Temperature (T _g)	0.7 °C	ASTM E1545
Coefficient of Thermal Expansion (CTE)	71 ppm/°C (Prior T _g) 137 ppm/°C (After T _g)	ASTM E831
Hardness	88 A	ASTM D2240
Tensile Strength	5.3 N/mm ²	ASTM D638
Compressive Strength	21 N/mm ²	ASTM D695

Cured Properties Continued

Lap Shear	3.7 N/mm ² (Stainless Steel) 2.7 N/mm ² (Aluminum) 1.2 N/mm ² (ABS) 1.6 N/mm ² (PC)	ASTM D1002
Resistivity	7.5 x 10 ¹¹ Ω-cm	ASTM D257
Breakdown Voltage @ 3.175 mm	41 400 V	ASTM D149
Dielectric Strength @ 3.175 mm	330 V/mil	
Dielectric Constant @ 1 MHz	4.5	ASTM D150
Dissipation Factor @ 1 MHz	0.04	
Chemical Absorption	18 % (Acetone)	—
Weight Gain, 30 days @ 25 °C	25 % (Ethyl Acetate) 9 % (IPA) 6 % (Sulphuric Acid 3%) 3 % (10% NaOH) 6 % (10% NaCl) 3 % (Water) 0 % (Transmission Oil) 0.2 % (Transformer Oil) 21 % (Gasoline)	

Application Instructions

Read the product SDS and Application Guide for more detailed instructions before using this product.

Recommended Preparation

Clean the substrate with 824 99.9% Isopropyl Alcohol, so the surface is free of oils, dust, and other residues.

Mixing

1. Scrape settled material free from the bottom and sides of the part A container; stir the contents until homogenous. Use a paint shaker if available.
2. Measure 1 parts by volume of the part A and pour into the mixing container. Ensure all contents are transferred by scraping the container.
3. Measure 1 part by volume of the part B and pour into the mixing container. Ensure all contents are transferred by scraping the container.
4. Thoroughly and gently mix parts A and B together. Avoid introducing air bubbles.
5. To de-air, let sit for 15 minutes or put in a vacuum chamber at 25 inHg for 2 minutes.
6. If bubbles are present at the top, break them gently with the mixing paddle.
7. Pour the mixture into a container holding the components to be protected.
8. Close the part A and B containers tightly between uses to prevent skinning.

If crystallization/solidification occurs, reconstitute the product by warming to between 55 and 65 °C until it becomes fully re-liquified. Let the material cool to room temperature before mixing, to prevent flash cure.

Mixing >1 kg at a time decreases working time and can lead to a flash cure. Limit the size of hand-mixed batches. For large production volumes, contact MG Chemicals Technical Support for assistance.

Disclaimer: This information is believed to be accurate. It is intended for professional end-users who have the skills required to evaluate and use the data properly. M.G. Chemicals Ltd. does not guarantee the accuracy of the data and assumes no liability in connection with damages incurred while using it.